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To the Honorable Com	1.3	100745586	al documents or copy thereof.
1. Name of conveying	pany(res):	, 100745560	Name and address of receiving party(ies):
Shosuke Tanaka,	Mitsutaka Enomoto and	l Teruyuki Yoshida	
Additional name(s) of	conveying party(les) at	tached? Yes X No	Name: Sony Corporation Internal Address:
Taglional name(s) of	evitoying party (less) as	100	
3. Nature of Conveya	nce:	5.2696	Street Address: 7-35 Kitashinagawa 6-chome
X Assignme	ent [Merger	Shinagawa-ku, Tokyo, Japan
☐ Security	Agreement [Change of Name	City State ZIP
Security			
Other			Additional name(s) & address(es) attached? Yes X No
	ay 7, May 11, and Ma		
4. Application number	i(s) or patent number(s): -	
		new application, the execution date	
A. Patent Ap 08/989,64	plication No.(s) 5		B. Patent No.(s)
		Additional numbers attached?	Yes 🗷 No
5. Name and address	of party to whom corre		6. Total number of applications and patents involved: 1
concerning docume	nt should be mailed:		o. I that number of appreautons and patents involved.
Name: Jay H. Maio	ali	-	
			7. Total fee (37 CFR 3.41): \$ 40.00
Internal Address:	Cooper & Dunham LLi	Consequence of the second content of the sec	
			Authorized to be charged to deposit account
Street Address: 1	185 Avenue of the Am	ericas	8. Deposit account number
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City: New York	State: New York	ZIP 10036	(Attach duplicate copy of this page if paying by deposit account)
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9. Statement and signa	ature.		
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copy of the	original document.	1 11111	
Jay H. Maioli		by XIM dioli	May 20, 1998
Name of Person Sig	ning	Signature	Date
			Tarri New Association
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Docket	Number:	54900

ASSIGNMENT WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in A CASSETTE MANAGING SYSTEM for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address: AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries; NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto; And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto; And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense; And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto; And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale. And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: ______, Filing Date: ______ This assignment executed on the dates indicated below. SHOSUKE TANAKA Name of first or sole inventor Execution date of U.S. Patent Application KANAGAWA, JAPAN Residence of first or sole inventor Signature of first or sole inventor



S97P1201US00

MITSUTAKA ENOMOTO

Name of second inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of second inventor	
Mitsutaka Enomoto	Mary 7, 1998 Date of this assignment
Signature of second investor	Date of this assignment
TERUYUKI YOSHIDA	
Name of third inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of third inventor Tenugular Centrals Signature of third inventor	May 1/ 1278. Date of this assignment
Signature of third inventor	Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
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Residence of fourth inventor	
Signature of fourth investor	Date of this assignment
Name of Effith Inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of Total Labration	Date of this wiferest

PATENT REEL: 9253 FRAME: 0069